

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2655306

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SOON YOENG TAN</td> <td>12/10/2013</td> </tr> <tr> <td>HUI LEANG ONG</td> <td>12/10/2013</td> </tr> </tbody> </table>		Name	Execution Date	SOON YOENG TAN	12/10/2013	HUI LEANG ONG	12/10/2013				
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SOON YOENG TAN	12/10/2013										
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>GLOBALFOUNDRIES SINGAPORE PTE. LTD.</td> </tr> <tr> <td>Street Address:</td> <td>60 WOODLANDS INDUSTRIAL PARK D STREET 2</td> </tr> <tr> <td>City:</td> <td>SINGAPORE</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>738406</td> </tr> </table>		Name:	GLOBALFOUNDRIES SINGAPORE PTE. LTD.	Street Address:	60 WOODLANDS INDUSTRIAL PARK D STREET 2	City:	SINGAPORE	State/Country:	SINGAPORE	Postal Code:	738406
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14134328</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14134328						
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CORRESPONDENCE DATA											
<p>Fax Number: (480)385-5061</p> <p>Phone: 480-385-5060</p> <p>Email: docketing@ifllaw.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: INGRASSIA FISHER & LORENZ, P.C. (GF)</p> <p>Address Line 1: 7010 E. COCHISE RD.</p> <p>Address Line 4: SCOTTSDALE, ARIZONA 85253</p>											
ATTORNEY DOCKET NUMBER:	126.0019(ESG043)										
NAME OF SUBMITTER:	RYAN T. FORTIN										
Signature:	/Ryan T. Fortin/										
Date:	12/19/2013										

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PATENT
 REEL: 031820 FRAME: 0589

OP \$40.00 14134328

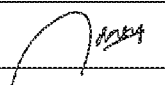
This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2


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COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	SEMICONDUCTOR WAFERS EMPLOYING A FIXED-COORDINATE METROLOGY SCHEME AND METHODS FOR FABRICATING INTEGRATED CIRCUITS USING THE SAME
DECLARATION	
As the below named inventor, I hereby declare that:	
This declaration is directed to:	<input checked="" type="checkbox"/> The attached application, or <input type="checkbox"/> United States application or PCT international application number _____ filed on _____
The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.	
ASSIGNMENT	
<p>For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.</p>	
If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.	
LEGAL NAME OF INVENTOR	
Inventor:	SOON YOENG TAN
Date:	12/10/2013
Signature:	
<p>Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.</p>	

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The above-identified application was made or authorized to be made by me.	
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.	
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ASSIGNMENT	
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.	
If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.	
LEGAL NAME OF INVENTOR	
Inventor:	HAI LEANG, ONG
Signature:	
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